



**Manufacturer's Name & Address:**

Advanced Micro Devices, Inc.  
7171 Southwest Parkway  
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Austin, Texas, USA 78735

## DECLARATION OF CONFORMITY

### SINGLE PLACE OF CONTACT

**EU**

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**U.K.**

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Regus - Midsummer Court, 314 Midsummer Boulevard  
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**TYPE OF EQUIPMENT:** Central Processing Unit (CPU)  
**TRADE NAME:** AMD  
**MARKETING NAME(S):** AMD Ryzen 9 7950X3D  
AMD Ryzen 9 7900X3D  
AMD Ryzen 7 7800X3D

### ADVANCED MICRO DEVICES, INC. DECLARES CONFORMITY TO THE ESSENTIAL REQUIREMENTS OF THE FOLLOWING DIRECTIVE(S) & LEGISLATION(S):

Electromagnetic Compatibility Directive 2014/30/EU  
U.K. S. I. No. 1091, Electromagnetic Compatibility Regulations 2016

### THE FOLLOWING HARMONIZED STANDARDS & TECHNICAL SPECIFICATIONS HAVE BEEN APPLIED:

EN 55032: 2015/A11: 2020/A11; CISPR32: 2015  
EN 61000-3-2: 2014  
EN 61000-3-3: 2013

EN 55035: 2017/A11:2020; CISPR 35: 2016

**Austin, Texas, USA**

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Signature

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Position / Title